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Amendments to the Claims

1 - 27 (canceled)

28. (currently amended) A method for uniformly removing an MCrAlY bonding layer disposed over a component, the bonding layer comprising one or more degradations which result in different reactivity in an acid bath compared to MCrAlY bonding layer regions lacking said degradations, the method comprising:

a first step, coarsely removing portions of the bonding layer;

subsequent to the first step, <u>using a heat treatment at a specified temperature</u> completely diffusing from a gas phase a diffusion agent comprising the elements <u>aluminum and cobaltat least two elements</u> into a remaining portion of the bonding layer, wherein <u>at least one said element of the diffusion agent diffuses into the component directly from a gas phase and whereinthe completely diffusing the diffusion agent causes a phase change in the remaining portion of the bonding layer so that both degraded and non-degraded regions of the bonding layer exhibit a more uniform reactivity in the acid bath; and</u>

uniformly removing the remaining portion of the bonding layer by exposure to the acid bath.

- 29. (previously presented) The method of claim 28, the coarsely removing step comprising mechanical sand blasting, immersing the component in an acid bath, or both.
- 30. (currently amended) The method of claim 28, the completely diffusing comprising diffusing a metalthe diffusion agent further comprising an additional and a second element selected from the group consisting of silicon and carbon.
 - 31. (cancelled)

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32. (previously presented) The method of claim 28, the completely diffusing comprising diffusing aluminum as a first element and cobalt as a second element, wherein the aluminum and cobalt diffusion into the remaining portion of the bonding layer causes γ and γ' phases to be converted into an aluminum-rich β phase, effective for allowing improved acid attack during the uniformly removing.

- 33. (cancelled)
- 34. (previously presented) The method of claim 28, wherein the M of the MCrAlY bonding layer is an element iron, cobalt or nickel.
- 35. (currently amended) The method of claim 34, wherein the <u>at least one said</u> <u>element of the diffusion agent diffuses into the component directly from a gas phase via completely diffusing comprises plasma spraying.</u>
- 36. (currently amended) The method of claim 34, wherein the <u>at least one said</u> <u>element of the diffusion agent diffuses into the component directly from a gas phase via completely diffusing comprises evaporation coating.</u>
- 37. (currently amended) The method of claim 34, wherein the <u>at least one said</u> <u>element of the diffusion agent diffuses into the component directly from a gas phase via completely diffusing comprises chemical vapor deposition.</u>

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38. (currently amended) A method for uniformly removing an MCrAIY bonding layer disposed over a component, the bonding layer comprising a partial area comprising corrosion products, the method comprising:

a first step, coarsely removing portions of the bonding layer;

subsequent to the first step, <u>using a heat treatment at a specified temperature</u> completely diffusing from a gas phase a diffusion agent comprising the elements aluminum and cobalt at least two elements into a remaining portion of the bonding layer wherein at least one said elements of the diffusion agent diffuses into the component directly from a gas phase; and

mechanically removing the partial area,

wherein the completely diffusing of the diffusion agent has enabled the partial area to become sufficiently brittle for the mechanically removing.

- 39. (previously presented) The method of claim 38, the bonding layer comprising a metal compound, and the coarsely removing step comprising mechanical sand blasting, immersing the component in an acid bath, or both.
- 40. (currently amended) The method of claim 38, the completely diffusing comprising diffusing the diffusion agent further comprising an additional a metal and a second element selected from the group consisting of silicon and carbon.
- 41. (previously presented) The method of claim 38, wherein the applying the diffusion agent causes a phase change in the remaining portion of the bonding layer.
 - 42. (cancelled)
- 43. (previously presented) The method of claim 38, wherein the M of the MCrAIY bonding layer is an element iron, cobalt or nickel.

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- 44. (currently amended) The method of claim 43, wherein the <u>at least one said</u> <u>element of the diffusion agent diffuses into the component directly from a gas phase via completely diffusing comprises plasma spraying.</u>
- 45. (currently amended) The method of claim 43, wherein the <u>at least one said</u> <u>element of the diffusion agent diffuses into the component directly from a gas phase via completely diffusing comprises evaporation coating.</u>
- 46. (currently amended) The method of claim 43, wherein the <u>at least one said</u> element of the diffusion agent diffuses into the component directly from a gas phase via completely diffusing comprises chemical vapor deposition.
- 47. (previously presented) The method as claimed in claim 38, the mechanically removing selecting from the group consisting of sand blasting, ultrasound treatment, and dry ice blasting.